



The Peer-reviewed International Journal

International Journal of Engineering Inventions

CERTIFICATE

It is certify that the paper entitled by "**Chemical-mechanical polishing of copper wafers utilizing an eco-friendly slurry**" is accepted for further publication in **International Journal of Engineering Inventions (IJEI)**.

Paper has published with following details:

Authors Name : **Le Dang Ha**
Journal Name : International Journal of Engineering Inventions (IJEI)
Journal URL : www.ijeijournal.com
Review Type : Peer Reviewed Journal
Publication Type : Online & Print both
ISSN No. : 2278-7461 (Online) ; 2319-6491 (Print)
Vol No. : 13
Issue No. : 6 (June 2024)



Editor-In-Chief
International Journal of Engineering Inventions (IJEI)
www.ijeijournal.com
Mail id: ijeijournal@editormails.com



The Peer-reviewed International Journal

International Journal of Engineering Inventions

CERTIFICATE

It is certify that the paper entitled by "**Chemical-mechanical polishing of copper wafers utilizing an eco-friendly slurry**" is accepted for further publication in **International Journal of Engineering Inventions (IJEI)**.

Paper has published with following details:

Authors Name : **Nguyen Nhat Minh**
Journal Name : International Journal of Engineering Inventions (IJEI)
Journal URL : www.ijeijournal.com
Review Type : Peer Reviewed Journal
Publication Type : Online & Print both
ISSN No. : 2278-7461 (Online) ; 2319-6491 (Print)
Vol No. : 13
Issue No. : 6 (June 2024)



Editor-In-Chief
International Journal of Engineering Inventions (IJEI)
www.ijeijournal.com
Mail id: ijeijournal@editormails.com